

# 74LVC245A; 74LVCH245A

Octal bus transceiver; 3-state

Rev. 8 — 28 June 2013

Product data sheet

## 1. General description

The 74LVC245A; 74LVCH245A are 8-bit transceivers featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features an output enable ( $\overline{OE}$ ) input for easy cascading and a send/receive (DIR) input for direction control.  $\overline{OE}$  controls the outputs so that the buses are effectively isolated.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH245A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

## 2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Inputs accept voltages up to 5.5 V
- High-impedance when  $V_{CC} = 0$  V
- Bus hold on all data inputs (74LVCH245A only)
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115B exceeds 200 V
  - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from  $-40$  °C to  $+85$  °C and  $-40$  °C to  $+125$  °C



### 3. Ordering information

Table 1. Ordering information

| Type number  | Package           |          |  |           |
|--------------|-------------------|----------|--|-----------|
|              | Temperature range | Name     | Description  | Version   |
| 74LVC245AD   | −40 °C to +125 °C | SO20     | plastic small outline package; 20 leads;<br>body width 7.5 mm  | SOT163-1  |
| 74LVCH245AD  |                   |          |  |           |
| 74LVC245ADB  | −40 °C to +125 °C | SSOP20   | plastic shrink small outline package; 20 leads;<br>body width 5.3 mm   | SOT339-1  |
| 74LVCH245ADB |                   |          |  |           |
| 74LVC245APW  | −40 °C to +125 °C | TSSOP20  | plastic thin shrink small outline package; 20 leads;<br>body width 4.4 mm  | SOT360-1  |
| 74LVCH245APW |                   |          |  |           |
| 74LVC245ABQ  | −40 °C to +125 °C | DHVQFN20 | plastic dual in-line compatible thermal enhanced<br>very thin quad flat package; no leads; 20 terminals;<br>body 2.5 × 4.5 × 0.85 mm     | SOT764-1  |
| 74LVCH245ABQ |                   |          |  |           |
| 74LVC245ABX  | −40 °C to +125 °C | DHXQFN20 | plastic dual in-line compatible thermal enhanced<br>extremely thin quad flat package; no leads; 20<br>terminals; body 4.5 × 2.5 × 0.5 mm | SOT1045-2 |
| 74LVCH245ABX |                   |          |  |           |

### 4. Functional diagram

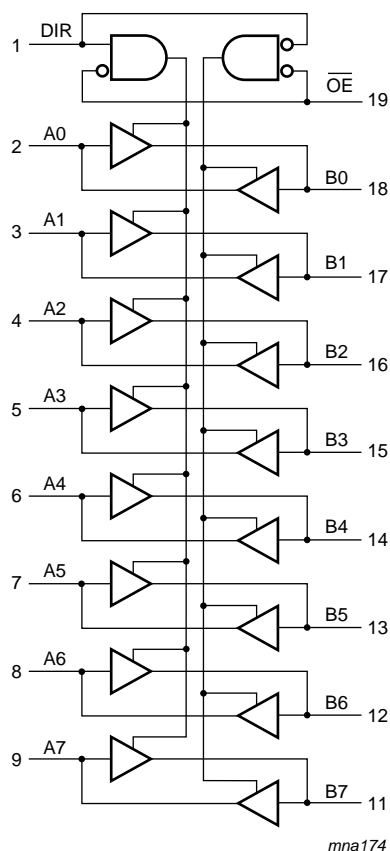


Fig 1. Logic diagram

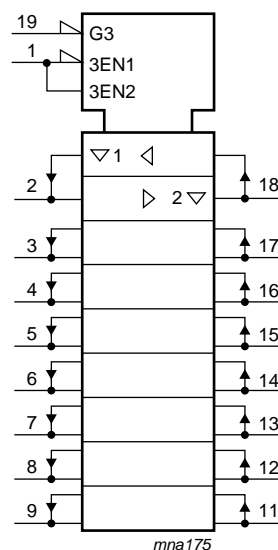
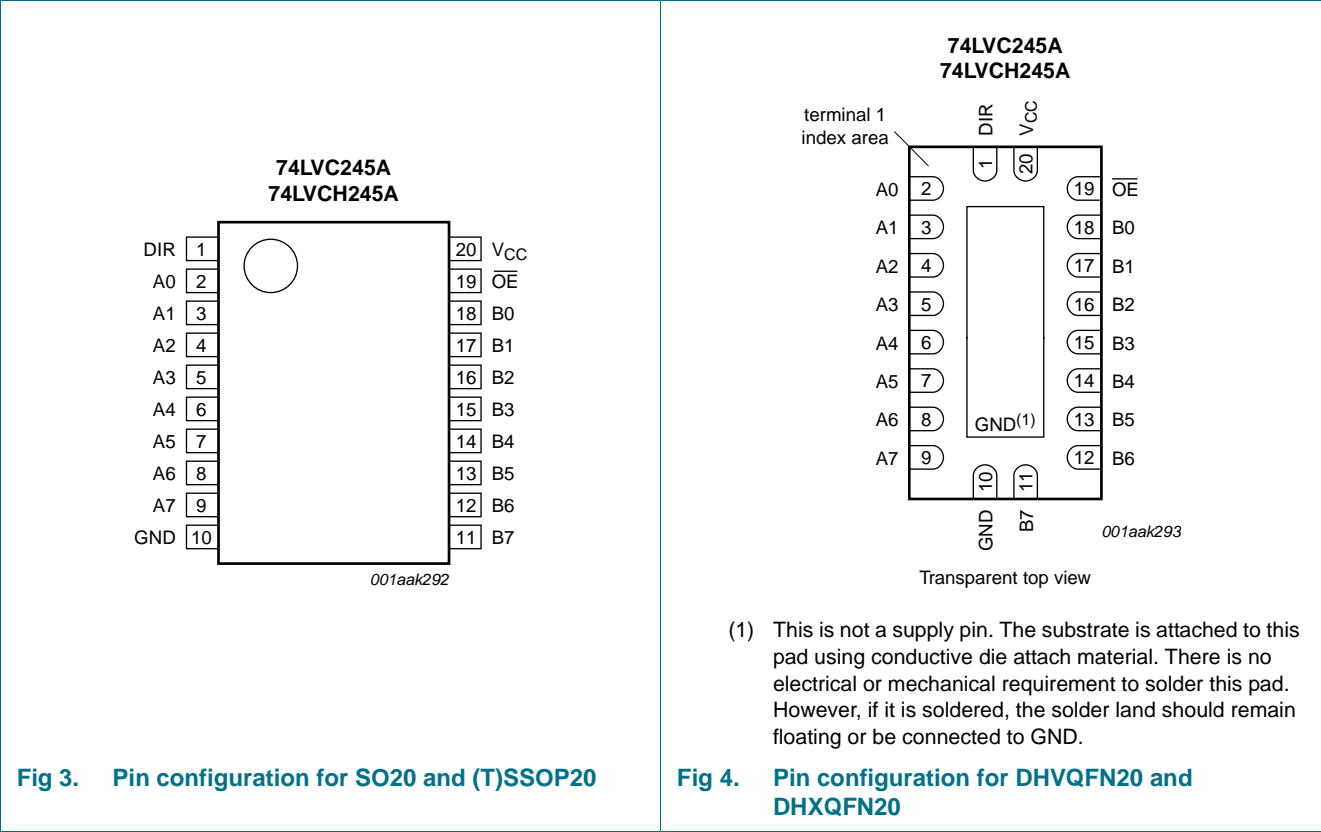


Fig 2. IEC logic symbol

5. Pinning information

5.1 Pinning



5.2 Pin description

| Table 2. Pin description |                                |                                  |
|--------------------------|--------------------------------|----------------------------------|
| Symbol                   | Pin                            | Description                      |
| DIR                      | 1                              | direction control                |
| A0 to A7                 | 2, 3, 4, 5, 6, 7, 8, 9         | data input/output                |
| GND                      | 10                             | ground (0 V)                     |
| B0 to B7                 | 18, 17, 16, 15, 14, 13, 12, 11 | data input/output                |
| $\overline{OE}$          | 19                             | output enable input (active LOW) |
| V <sub>CC</sub>          | 20                             | supply voltage                   |

## 6. Functional description

Table 3. Function selection<sup>[1]</sup>

| Inputs |     | Inputs/outputs |         |
|--------|-----|----------------|---------|
| OE     | DIR | An             | Bn      |
| L      | L   | An = Bn        | inputs  |
| L      | H   | inputs         | Bn = An |
| H      | X   | Z              | Z       |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high impedance OFF-state.

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                    | Min                 | Max            | Unit |
|-----------|-------------------------|-------------------------------|---------------------|----------------|------|
| $V_{CC}$  | supply voltage          |                               | -0.5                | +6.5           | V    |
| $I_{IK}$  | input clamping current  | $V_I < 0$ V                   | -50                 | -              | mA   |
| $V_I$     | input voltage           |                               | <sup>[1]</sup> -0.5 | +6.5           | V    |
| $I_{OK}$  | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V | -                   | ±50            | mA   |
| $V_O$     | output voltage          | output HIGH or LOW            | <sup>[2]</sup> -0.5 | $V_{CC} + 0.5$ | V    |
|           |                         | output 3-state                | <sup>[2]</sup> -0.5 | +6.5           | V    |
| $I_O$     | output current          | $V_O = 0$ V to $V_{CC}$       | -                   | ±50            | mA   |
| $I_{CC}$  | supply current          |                               | -                   | 100            | mA   |
| $I_{GND}$ | ground current          |                               | -100                | -              | mA   |
| $T_{stg}$ | storage temperature     |                               | -65                 | +150           | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to +125 °C | <sup>[3]</sup> -    | 500            | mW   |

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO20 packages: above 70 °C derate linearly with 8 mW/K.

For (T)SSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.

For DHVQFN20 and DHXQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol              | Parameter                           | Conditions                              | Min  | Typ | Max      | Unit |
|---------------------|-------------------------------------|---|------|-----|----------|------|
| $V_{CC}$            | supply voltage                      |   | 1.65 | -   | 3.6      | V    |
|                     |                                     | functional                              | 1.2  | -   | 3.6      | V    |
| $V_I$               | input voltage                       |   | 0    | -   | 5.5      | V    |
| $V_O$               | output voltage                      | output HIGH or LOW                      | 0    | -   | $V_{CC}$ | V    |
|                     |                                     | output 3-state                          | 0    | -   | 5.5      | V    |
| $T_{amb}$           | ambient temperature                 | in free air                             | -40  | -   | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 1.2\text{ V to }2.7\text{ V}$ | 0    | -   | 20       | ns/V |
|                     |                                     | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ | 0    | -   | 10       | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol   | Parameter                 | Conditions  | -40 °C to +85 °C     |                    |                      | -40 °C to +125 °C    |                      | Unit                        |
|----------|---------------------------|---|----------------------|--------------------|----------------------|----------------------|----------------------|-----------------------------|
|          |                           |   | Min                  | Typ <sup>[1]</sup> | Max                  | Min                  | Max                  |                             |
| $V_{IH}$ | HIGH-level input voltage  | $V_{CC} = 1.2\text{ V}$   | 1.08                 | -                  | -                    | 1.08                 | -                    | V                           |
|          |                           | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                               | $0.65 \times V_{CC}$ | -                  | -                    | $0.65 \times V_{CC}$ | -                    | V                           |
|          |                           | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$                                 | 1.7                  | -                  | -                    | 1.7                  | -                    | V                           |
|          |                           | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$                                 | 2.0                  | -                  | -                    | 2.0                  | -                    | V                           |
| $V_{IL}$ | LOW-level input voltage   | $V_{CC} = 1.2\text{ V}$   | -                    | -                  | 0.12                 | -                    | 0.12                 | V                           |
|          |                           | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                               | -                    | -                  | $0.35 \times V_{CC}$ | -                    | $0.35 \times V_{CC}$ | V                           |
|          |                           | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$                                 | -                    | -                  | 0.7                  | -                    | 0.7                  | V                           |
|          |                           | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$                                 | -                    | -                  | 0.8                  | -                    | 0.8                  | V                           |
| $V_{OH}$ | HIGH-level output voltage | $V_I = V_{IH}\text{ or }V_{IL}$   |                      |                    |                      |                      |                      |                             |
|          |                           | $I_O = -100\text{ }\mu\text{A}; V_{CC} = 1.65\text{ V to }3.6\text{ V}$ | $V_{CC} - 0.2$       | -                  | -                    | $V_{CC} - 0.3$       | -                    | V                           |
|          |                           | $I_O = -4\text{ mA}; V_{CC} = 1.65\text{ V}$                            | 1.2                  | -                  | -                    | 1.05                 | -                    | V                           |
|          |                           | $I_O = -8\text{ mA}; V_{CC} = 2.3\text{ V}$                             | 1.8                  | -                  | -                    | 1.65                 | -                    | V                           |
|          |                           | $I_O = -12\text{ mA}; V_{CC} = 2.7\text{ V}$                            | 2.2                  | -                  | -                    | 2.05                 | -                    | V                           |
|          |                           | $I_O = -18\text{ mA}; V_{CC} = 3.0\text{ V}$                            | 2.4                  | -                  | -                    | 2.25                 | -                    | V                           |
|          |                           | $I_O = -24\text{ mA}; V_{CC} = 3.0\text{ V}$                            | 2.2                  | -                  | -                    | 2.0                  | -                    | V                           |
| $V_{OL}$ | LOW-level output voltage  | $V_I = V_{IH}\text{ or }V_{IL}$   |                      |                    |                      |                      |                      |                             |
|          |                           | $I_O = 100\text{ }\mu\text{A}; V_{CC} = 1.65\text{ V to }3.6\text{ V}$  | -                    | -                  | 0.2                  | -                    | 0.3                  | V                           |
|          |                           | $I_O = 4\text{ mA}; V_{CC} = 1.65\text{ V}$                             | -                    | -                  | 0.45                 | -                    | 0.65                 | V                           |
|          |                           | $I_O = 8\text{ mA}; V_{CC} = 2.3\text{ V}$                              | -                    | -                  | 0.6                  | -                    | 0.8                  | V                           |
|          |                           | $I_O = 12\text{ mA}; V_{CC} = 2.7\text{ V}$                             | -                    | -                  | 0.4                  | -                    | 0.6                  | V                           |
|          |                           | $I_O = 24\text{ mA}; V_{CC} = 3.0\text{ V}$                             | -                    | -                  | 0.55                 | -                    | 0.8                  | V                           |
| $I_I$    | input leakage current     | $V_I = 5.5\text{ V or GND}; V_{CC} = 3.6\text{ V}$                      | <sup>[2]</sup>       | -                  | $\pm 0.1$            | $\pm 5$              | -                    | $\pm 20\text{ }\mu\text{A}$ |

**Table 6.** Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol            | Parameter                       | Conditions  | –40 °C to +85 °C |                    |     | –40 °C to +125 °C |      | Unit |
|-------------------|---------------------------------|---|------------------|--------------------|-----|-------------------|------|------|
|                   |                                 |   | Min              | Typ <sup>[1]</sup> | Max | Min               | Max  |      |
| I <sub>OZ</sub>   | OFF-state output current        | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>V <sub>O</sub> = 5.5 V or GND;<br>V <sub>CC</sub> = 3.6 V    | -                | ±0.1               | ±5  | -                 | ±20  | µA   |
| I <sub>OFF</sub>  | power-off leakage current       | V <sub>I</sub> or V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 0.0 V   | -                | ±0.1               | ±10 | -                 | ±20  | µA   |
| I <sub>CC</sub>   | supply current                  | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A;<br>V <sub>CC</sub> = 3.6 V                             | -                | 0.1                | 10  | -                 | 40   | µA   |
| ΔI <sub>CC</sub>  | additional supply current       | per input pin;<br>V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; I <sub>O</sub> = 0 A;<br>V <sub>CC</sub> = 2.7 V to 3.6 V | -                | 5                  | 500 | -                 | 5000 | µA   |
| C <sub>I</sub>    | input capacitance               | V <sub>CC</sub> = 0 V to 3.6 V;<br>V <sub>I</sub> = GND to V <sub>CC</sub>  | -                | 4.0                | -   | -                 | -    | pF   |
| C <sub>I/O</sub>  | input/output capacitance        | V <sub>CC</sub> = 0 V to 3.6 V;<br>V <sub>I</sub> = GND to V <sub>CC</sub>  | -                | 10                 | -   | -                 | -    | pF   |
| I <sub>BHL</sub>  | bus hold LOW current            | V <sub>CC</sub> = 1.65; V <sub>I</sub> = 0.58 V   | 10               | -                  | -   | 10                | -    | µA   |
|                   |                                 | V <sub>CC</sub> = 2.3; V <sub>I</sub> = 0.7 V   | 30               | -                  | -   | 25                | -    | µA   |
|                   |                                 | V <sub>CC</sub> = 3.0; V <sub>I</sub> = 0.8 V   | 75               | -                  | -   | 60                | -    | µA   |
| I <sub>BHH</sub>  | bus hold HIGH current           | V <sub>CC</sub> = 1.65; V <sub>I</sub> = 1.07 V   | –10              | -                  | -   | –10               | -    | µA   |
|                   |                                 | V <sub>CC</sub> = 2.3; V <sub>I</sub> = 1.7 V   | –30              | -                  | -   | –25               | -    | µA   |
|                   |                                 | V <sub>CC</sub> = 3.0; V <sub>I</sub> = 2.0 V   | –75              | -                  | -   | –60               | -    | µA   |
| I <sub>BHLO</sub> | bus hold LOW overdrive current  | V <sub>CC</sub> = 1.95 V  | 200              | -                  | -   | 200               | -    | µA   |
|                   |                                 | V <sub>CC</sub> = 2.7 V   | 300              | -                  | -   | 300               | -    | µA   |
|                   |                                 | V <sub>CC</sub> = 3.6 V   | 500              | -                  | -   | 500               | -    | µA   |
| I <sub>BHHO</sub> | bus hold HIGH overdrive current | V <sub>CC</sub> = 1.95 V  | –200             | -                  | -   | –200              | -    | µA   |
|                   |                                 | V <sub>CC</sub> = 2.7 V   | –300             | -                  | -   | –300              | -    | µA   |
|                   |                                 | V <sub>CC</sub> = 3.6 V   | –500             | -                  | -   | –500              | -    | µA   |

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.[2] The bus hold circuit is switched off when V<sub>I</sub> > V<sub>CC</sub> allowing 5.5 V on the input terminal.[3] For I/O ports the parameter I<sub>OZ</sub> includes the input leakage current.

[4] Valid for data inputs of bus hold parts only (74LVCH245A). Note that control inputs do not have a bus hold circuit.

[5] The specified sustaining current at the data input holds the input below the specified V<sub>I</sub> level.

[6] The specified overdrive current at the data input forces the data input to the opposite input state.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 7](#).

| Symbol             | Parameter                     | Conditions  | –40 °C to +85 °C |                    |      | –40 °C to +125 °C |      | Unit |
|--------------------|-------------------------------|---|------------------|--------------------|------|-------------------|------|------|
|                    |                               |   | Min              | Typ <sup>[2]</sup> | Max  | Min               | Max  |      |
| t <sub>pd</sub>    | propagation delay             | nAn to nBn; nBn to nAn; see <a href="#">Figure 5</a> <sup>[1]</sup> |                  |                    |      |                   |      |      |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                | 17.0               | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                  | 1.5              | 6.5                | 14.6 | 1.5               | 16.9 | ns   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                    | 1.0              | 3.4                | 7.6  | 1.0               | 8.7  | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.5              | 3.4                | 7.3  | 1.5               | 9.5  | ns   |
| t <sub>en</sub>    | enable time                   | nOE to nAn, nBn; see <a href="#">Figure 6</a> <sup>[1]</sup>        |                  |                    |      |                   |      |      |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                | 22.0               | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                  | 1.9              | 8.3                | 19.5 | 1.9               | 22.5 | ns   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                    | 1.5              | 4.6                | 10.7 | 1.5               | 12.4 | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.5              | 4.8                | 9.5  | 1.5               | 12.0 | ns   |
| t <sub>dis</sub>   | disable time                  | nOE to nAn, nBn; see <a href="#">Figure 6</a> <sup>[1]</sup>        |                  |                    |      |                   |      |      |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                | 12.0               | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                  | 2.9              | 5.5                | 12.3 | 2.9               | 14.2 | ns   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                    | 1.0              | 3.1                | 7.1  | 1.0               | 8.2  | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.5              | 3.9                | 8.0  | 1.5               | 10.0 | ns   |
| t <sub>sk(o)</sub> | output skew time              | V <sub>CC</sub> = 3.0 V to 3.6 V                                    | 1.5              | 3.7                | 8.5  | 1.5               | 11.0 | ns   |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                | 12.0               | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                  | 2.9              | 5.5                | 12.3 | 2.9               | 14.2 | ns   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                    | 1.0              | 3.1                | 7.1  | 1.0               | 8.2  | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.5              | 3.9                | 8.0  | 1.5               | 10.0 | ns   |
| C <sub>PD</sub>    | power dissipation capacitance | per input; V <sub>I</sub> = GND to V <sub>CC</sub> <sup>[4]</sup>   |                  |                    |      |                   |      |      |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                  | -                | 7.7                | -    | -                 | -    | pF   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                    | -                | 11.3               | -    | -                 | -    | pF   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                    | -                | 14.4               | -    | -                 | -    | pF   |

[1] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.

t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.

[2] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz

C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

11. AC waveforms

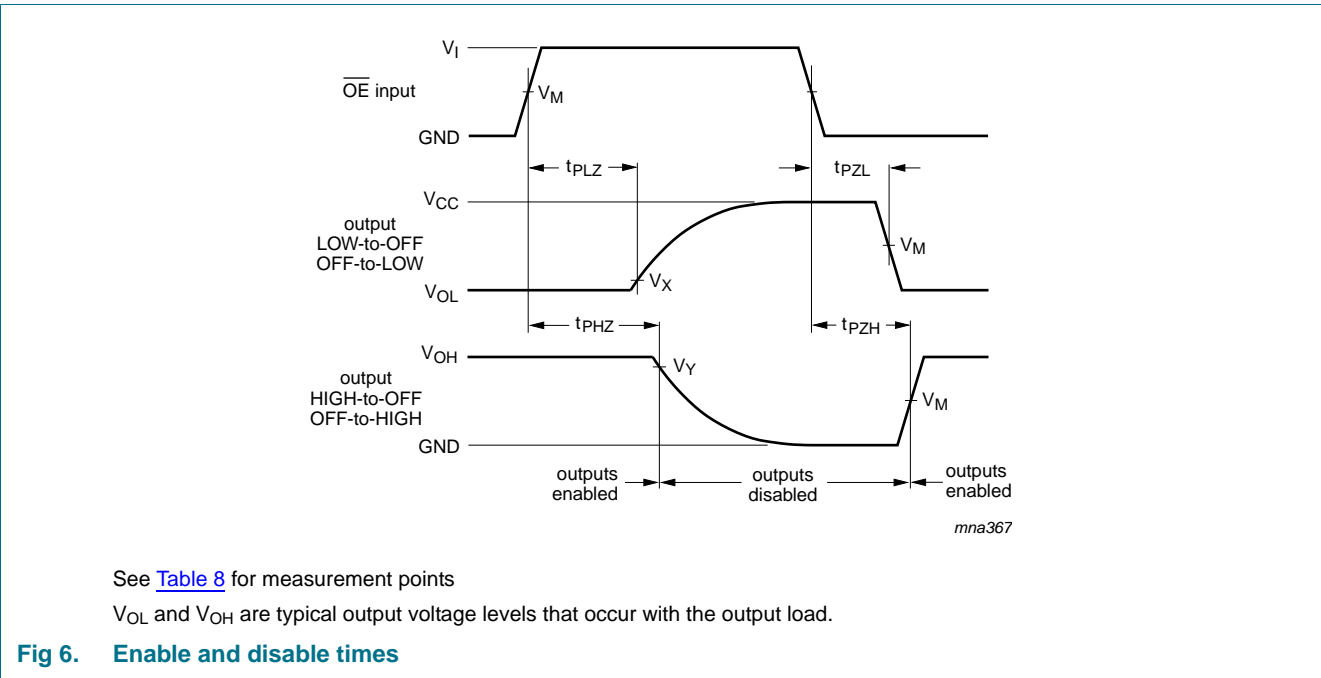
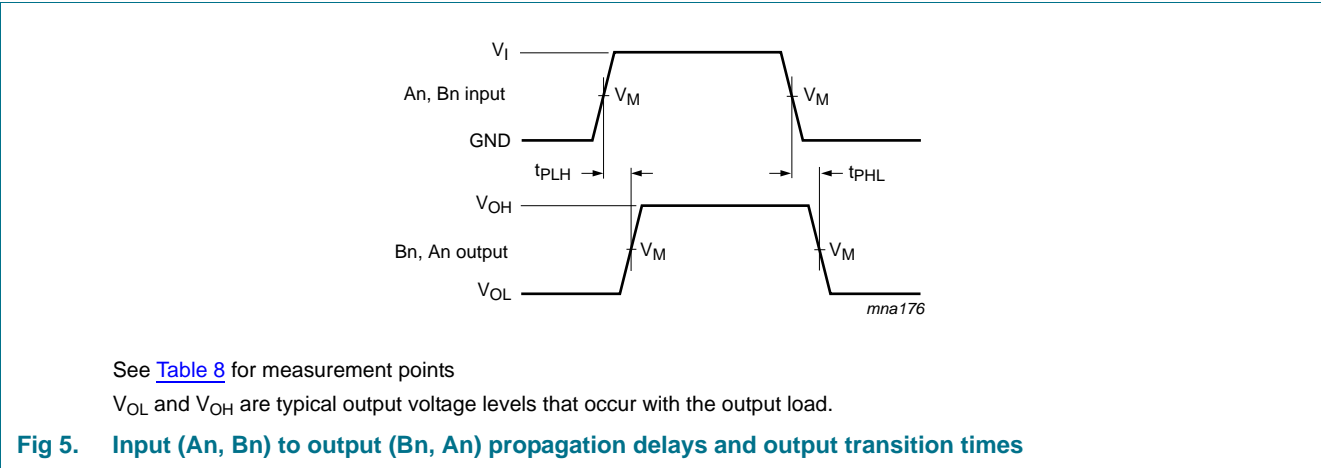
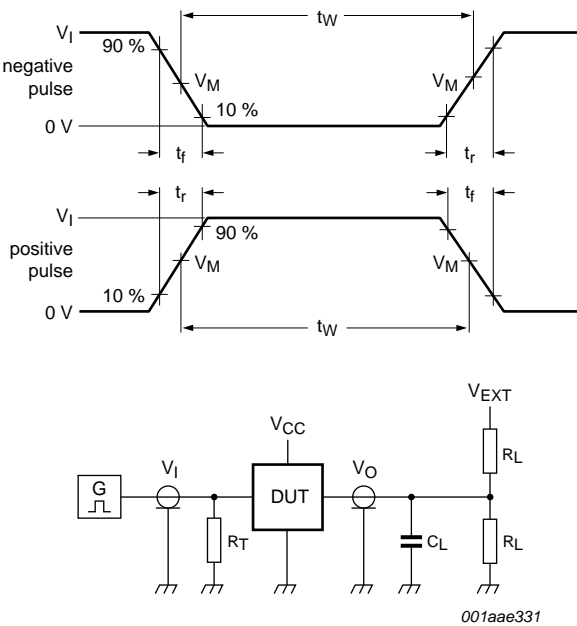


Table 8. Measurement points

| Supply voltage   | $V_M$               | Input    |               |                   |                   |
|------------------|---------------------|----------|---------------|-------------------|-------------------|
| $V_{CC}$         |                     | $V_I$    | $t_r = t_f$   | $V_X$             | $V_Y$             |
| 1.2 V            | $0.5 \times V_{CC}$ | $V_{CC}$ | $\leq 2.5$ ns | $V_{OL} + 0.15$ V | $V_{OH} - 0.15$ V |
| 1.65 V to 1.95 V | $0.5 \times V_{CC}$ | $V_{CC}$ | $\leq 2.5$ ns | $V_{OL} + 0.15$ V | $V_{OH} - 0.15$ V |
| 2.3 V to 2.7 V   | $0.5 \times V_{CC}$ | $V_{CC}$ | $\leq 2.5$ ns | $V_{OL} + 0.15$ V | $V_{OH} - 0.15$ V |
| 2.7 V            | 1.5 V               | 2.7 V    | $\leq 2.5$ ns | $V_{OL} + 0.3$ V  | $V_{OH} - 0.3$ V  |
| 3.0 V to 3.6 V   | 1.5 V               | 2.7 V    | $\leq 2.5$ ns | $V_{OL} + 0.3$ V  | $V_{OH} - 0.3$ V  |





Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = External voltage for measuring switching times.

**Fig 7. Test circuit for measuring switching times**

**Table 9. Test data**

| Supply voltage   | Input    |               | Load  |              | $V_{EXT}$          |                    |                    |
|------------------|----------|---------------|-------|--------------|--------------------|--------------------|--------------------|
|                  | $V_I$    | $t_r, t_f$    | $C_L$ | $R_L$        | $t_{PLH}, t_{PHL}$ | $t_{PLZ}, t_{PZL}$ | $t_{PHZ}, t_{PZH}$ |
| 1.2 V            | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 1 k $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 1.65 V to 1.95 V | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 1 k $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.3 V to 2.7 V   | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.7 V            | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 3.0 V to 3.6 V   | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |

12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

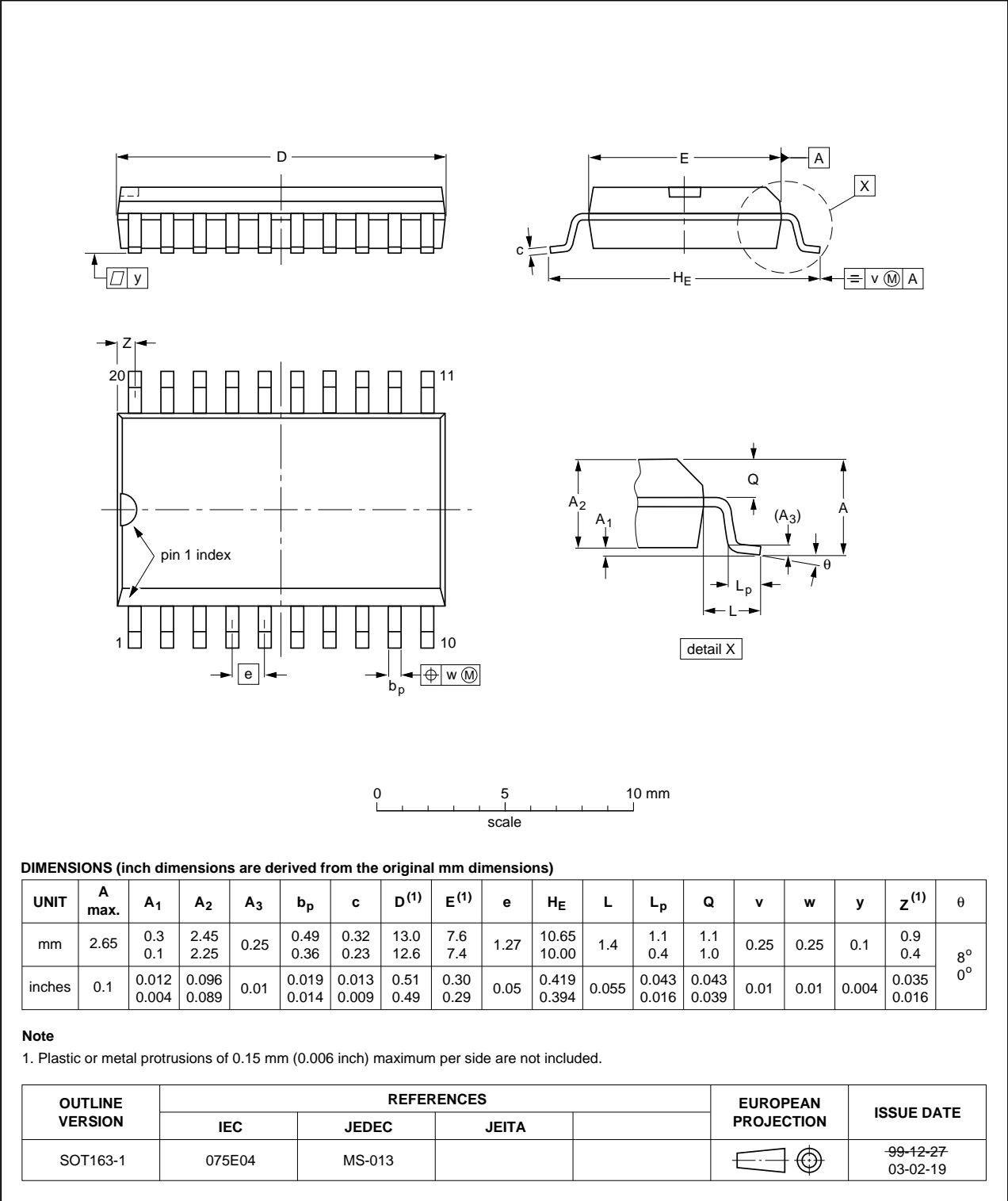


Fig 8. Package outline SOT163-1 (SO20)

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1

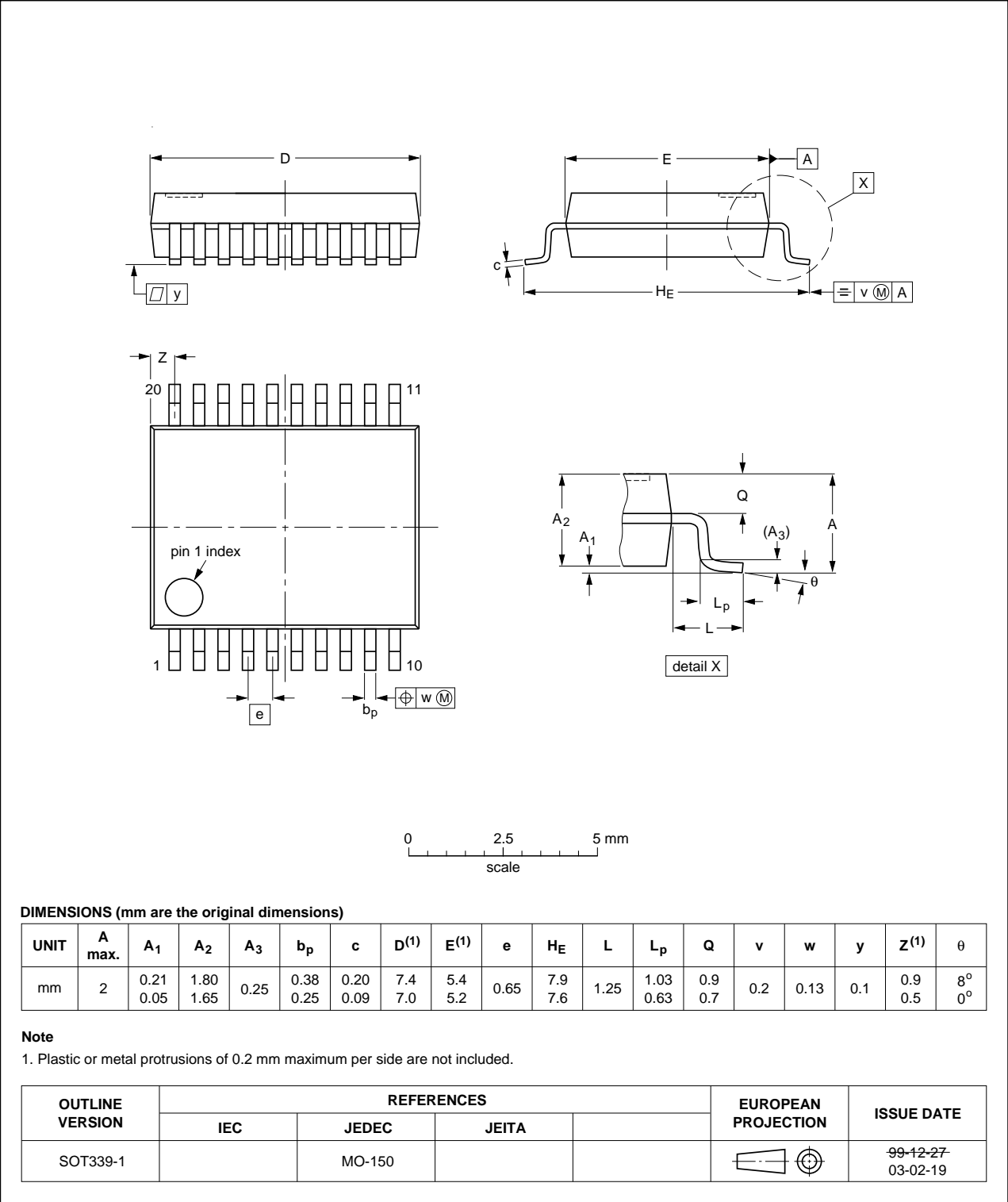


Fig 9. Package outline SOT339-1 (SSOP20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

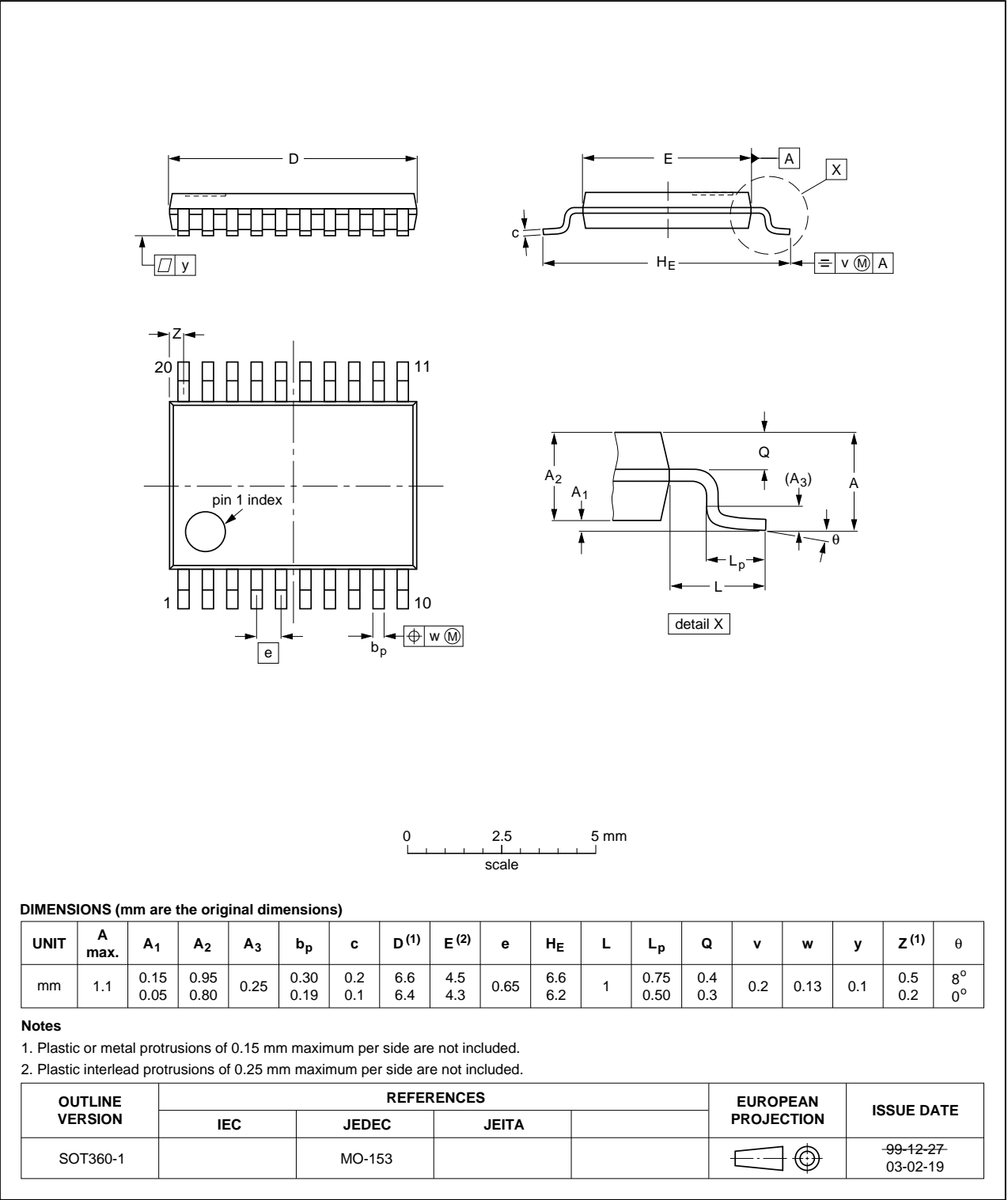


Fig 10. Package outline SOT360-1 (TSSOP20)

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;  
20 terminals; body 2.5 x 4.5 x 0.85 mm

SOT764-1

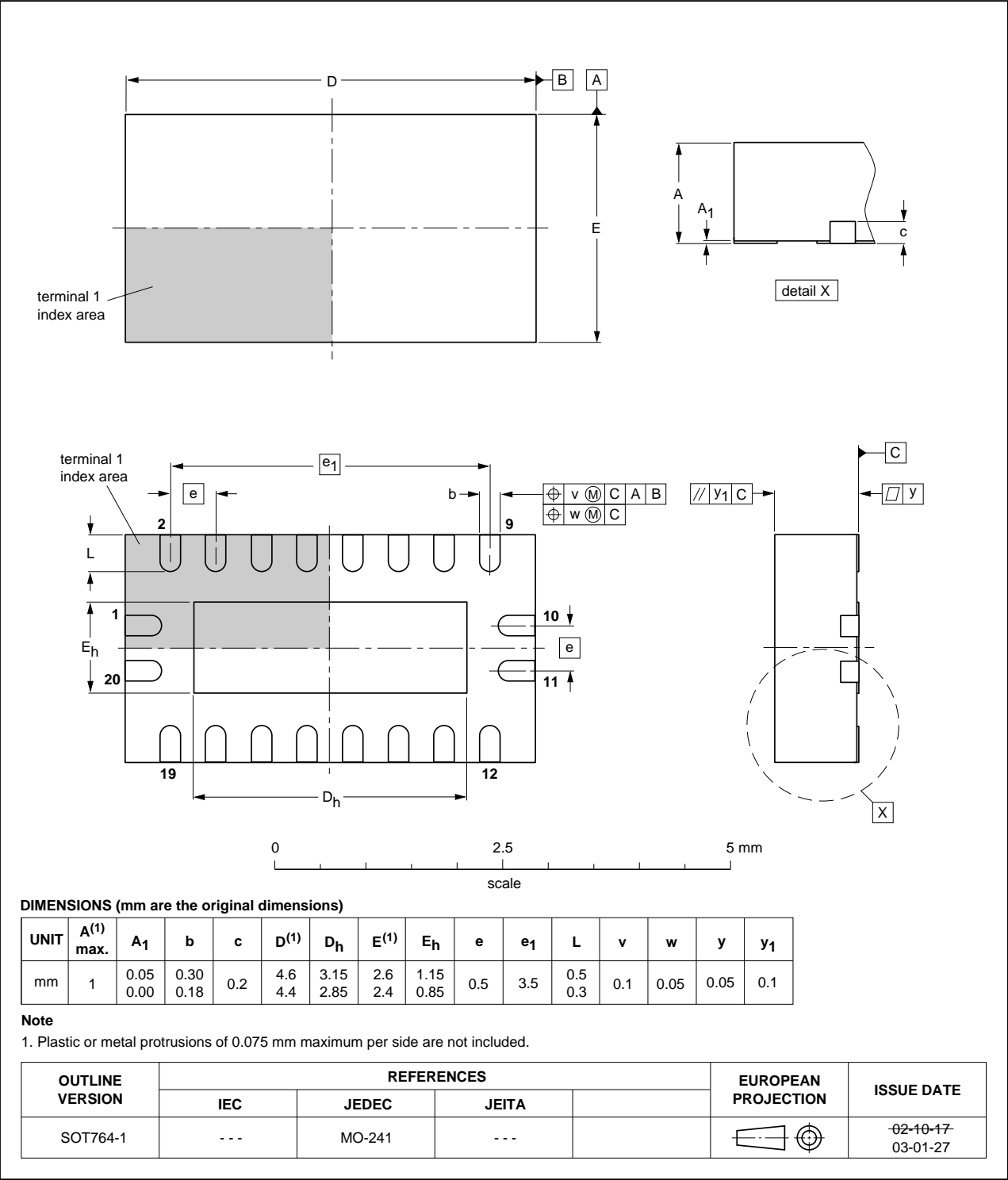


Fig 11. Package outline SOT764-1 (DHVQFN20)

DHXQFN20U: plastic dual in-line compatible thermal enhanced extremely thin quad flat package;  
no leads; 20 terminals; UTLP based; body 2.5 x 4.5 x 0.5 mm

SOT1045-1

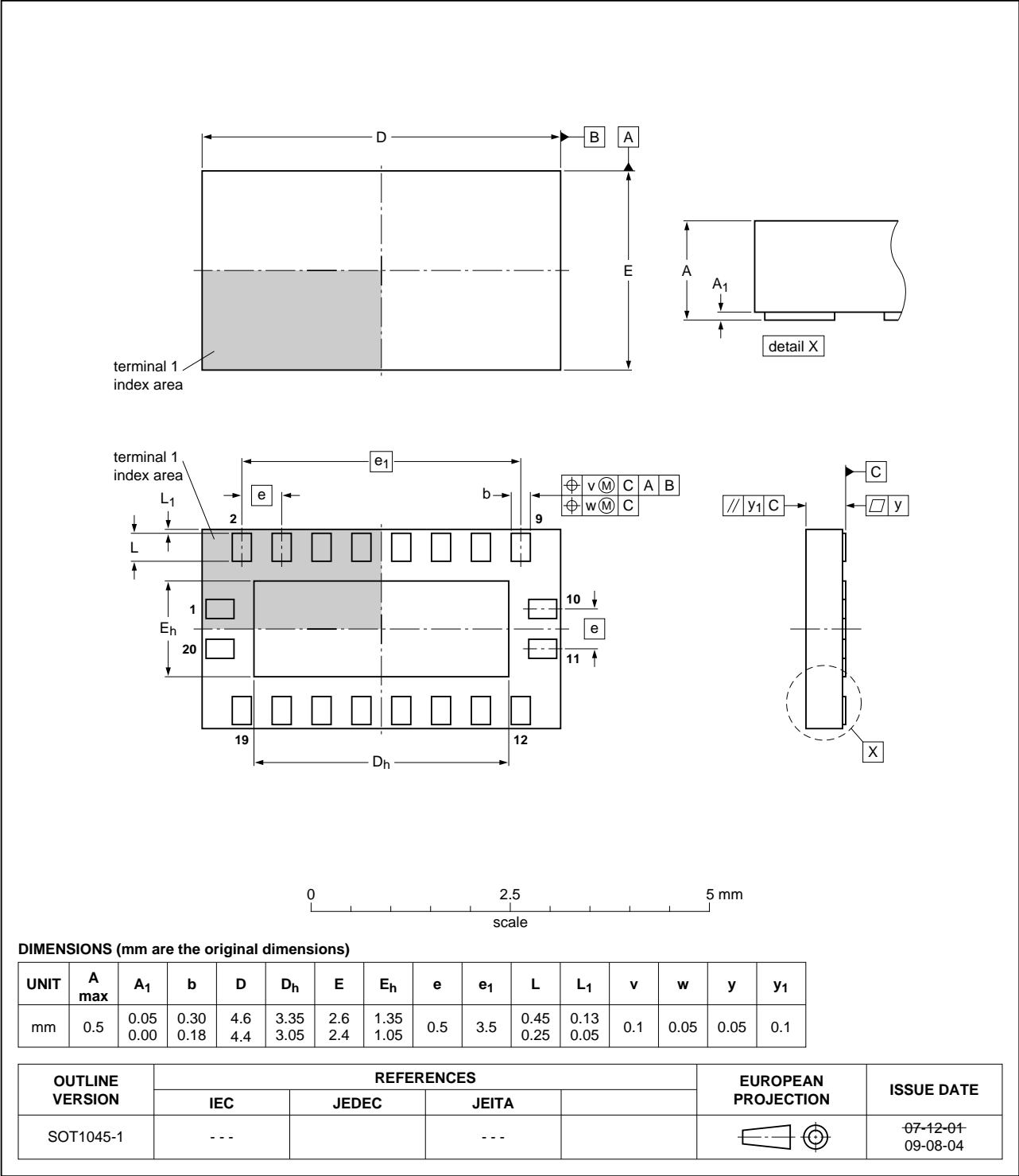


Fig 12. Package outline SOT1045-2 (DHXQFN20)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                             |
|---------|---|
| CDM     | Charged Device Model                    |
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 14. Revision history

Table 11. Revision history

| Document ID              | Release date  | Data sheet status     | Change notice | Supersedes               |
|--------------------------|---|-----------------------|---------------|--------------------------|
| 74LVC_LVCH245A v.8       | 20130628  | Product data sheet    | -             | 74LVC_LVCH245A v.7       |
| Modifications:           | <ul style="list-style-type: none"> <li>For type numbers 74LVC245ABX and 74LVCH245ABX DHXQFN20U (SOT1045-1) has changed to DHXQFN20 (SOT1045-2).</li> </ul>  |                       |               |                          |
| 74LVC_LVCH245A v.7       | 20120405  | Product data sheet    | -             | 74LVC_LVCH245A v.6       |
| Modifications:           | <ul style="list-style-type: none"> <li><a href="#">Table note 4</a> of <a href="#">Table 6</a>: corrected (errata)</li> </ul>   |                       |               |                          |
| 74LVC_LVCH245A v.6       | 20111125  | Product data sheet    | -             | 74LVC_LVCH245A v.5       |
| Modifications:           | <ul style="list-style-type: none"> <li><a href="#">Table 4</a>, <a href="#">Table 5</a>, <a href="#">Table 6</a>, <a href="#">Table 7</a>, and <a href="#">Table 9</a>: values added for lower voltage ranges.</li> </ul> |                       |               |                          |
| 74LVC_LVCH245A v.5       | 20090825  | Product data sheet    | -             | 74LVC_LVCH245A v.4       |
| 74LVC_LVCH245A v.4       | 20090703  | Product data sheet    | -             | 74LVC_LVCH245A v.3       |
| 74LVC_LVCH245A v.3       | 20030507  | Product specification | -             | 74LVC245A_74LVCH245A v.2 |
| 74LVC245A_74LVCH245A v.2 | 20020620  | Product specification | -             | 74LVC245A_74LVCH245A v.1 |
| 74LVC245A_74LVCH245A v.1 | 19971219  | Product specification | -             | -                        |

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| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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## 17. Contents

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|           |   |           |
|-----------|---|-----------|
| <b>1</b>  | <b>General description</b> .....              | <b>1</b>  |
| <b>2</b>  | <b>Features and benefits</b> .....            | <b>1</b>  |
| <b>3</b>  | <b>Ordering information</b> .....             | <b>2</b>  |
| <b>4</b>  | <b>Functional diagram</b> .....               | <b>2</b>  |
| <b>5</b>  | <b>Pinning information</b> .....              | <b>3</b>  |
| 5.1       | Pinning .....                                 | 3         |
| 5.2       | Pin description .....                         | 3         |
| <b>6</b>  | <b>Functional description</b> .....           | <b>4</b>  |
| <b>7</b>  | <b>Limiting values</b> .....                  | <b>4</b>  |
| <b>8</b>  | <b>Recommended operating conditions</b> ..... | <b>5</b>  |
| <b>9</b>  | <b>Static characteristics</b> .....           | <b>5</b>  |
| <b>10</b> | <b>Dynamic characteristics</b> .....          | <b>7</b>  |
| <b>11</b> | <b>AC waveforms</b> .....                     | <b>8</b>  |
| <b>12</b> | <b>Package outline</b> .....                  | <b>10</b> |
| <b>13</b> | <b>Abbreviations</b> .....                    | <b>15</b> |
| <b>14</b> | <b>Revision history</b> .....                 | <b>15</b> |
| <b>15</b> | <b>Legal information</b> .....                | <b>16</b> |
| 15.1      | Data sheet status .....                       | 16        |
| 15.2      | Definitions .....                             | 16        |
| 15.3      | Disclaimers .....                             | 16        |
| 15.4      | Trademarks .....                              | 17        |
| <b>16</b> | <b>Contact information</b> .....              | <b>17</b> |
| <b>17</b> | <b>Contents</b> .....                         | <b>18</b> |

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